



30V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C		
30V	$21m\Omega$ @ $V_{GS} = 10V$	30A		
	$35m\Omega$ @ $V_{GS} = 4.5V$	24A		

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

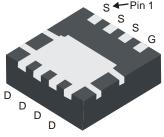
Features and Benefits

- Low R_{DS(ON)} Ensures On-State Losses are Minimized
- Small form factor thermally efficient package enables higher density end products (PowerDI[®])
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMN3018SFGQ</u>)

Mechanical Data

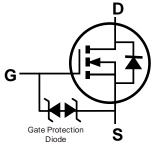
- Case: PowerDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 93
- Weight: 0.072 grams (Approximate)





Bottom View





Top View



Top View Internal Schematic

Ordering Information (Note 4)

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I	Part Number	Case	Packaging
I	DMN3018SFG-7	PowerDI3333-8	2000/Tape & Reel
	DMN3018SFG-13	PowerDI3333-8	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



N38 = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 16 = 2016) WW = Week Code (01 – 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	±25	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	$T_C = +25$ °C $T_C = +70$ °C	ΙD	30 25	А
Continuous Drain Current (Note 6) // 40)/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	ΙD	8.5 6.8	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	ΙD	11.3 9.1	А
Continuous Durin Compart (Note C) // 45/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	6.6 5.3	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	8.7 7.0	А
Maximum Continuous Body Diode Forward Current	Is	2.5	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	60	Α		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	18	Α		
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	16	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 5)		P_{D}	1.0	W	
Thermal Desigtance, Junction to Ambient (Note 5)		-	126	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	71	J C/VV	
Total Power Dissipation (Note 6)		P _D	2.2	W	
Thermal Resistance, Junction to Ambient (Note 6)		Ъ	56		
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	31	°C/W	
Thermal Resistance, Junction to Case (Note 6)		R ₀ JC	7.0		
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to 150	°C	

Electrical Characteristics (@T_A = ±25°C, unless otherwise specified.)

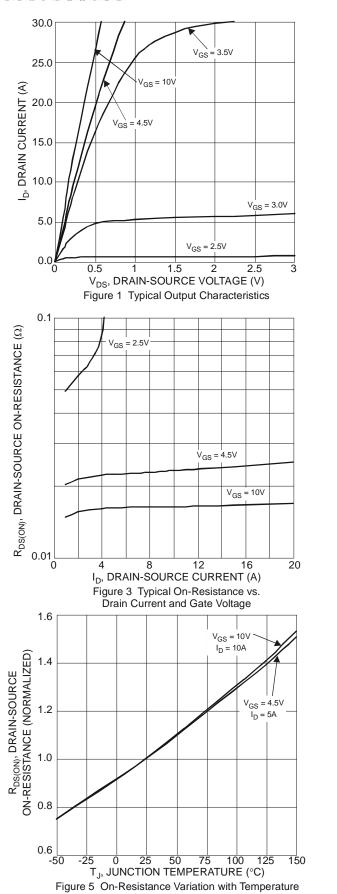
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage		30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μΑ	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1	1.7	2.1	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance			16	21	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Dialii-Source Off-Resistance	R _{DS(ON)}	_	21	35		$V_{GS} = 4.5V, I_D = 8.5A$	
Diode Forward Voltage	V_{SD}	0.5	_	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{ISS}	-	697	_	pF	1/ 15// // 0)/	
Output Capacitance	Coss	1	97	_	рF	$V_{DS} = 15V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C _{RSS}		67	_	рF	11 = 1.0WHZ	
Gate resistance	R _G	1	1.47	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_{G}	1	6.0	_	nC		
Total Gate Charge (V _{GS} = 10V)	Q_G	1	13.2	_	nC	$V_{GS} = 10V, V_{DS} = 15V,$	
Gate-Source Charge	Q_{GS}	_	2.2	_	nC	$I_D = 9A$	
Gate-Drain Charge	Q_{GD}	_	1.8	_	nC	1	
Turn-On Delay Time	t _{D(ON)}	_	4.3	_	ns		
Turn-On Rise Time	t _R	_	4.4	_	ns	$V_{DD} = 15V, V_{GS} = 10V,$ $R_{L} = 15\Omega, I_{D} = 1A, R_{G} = 6\Omega$	
Turn-Off Delay Time	t _{D(OFF)}	_	20.1	_	ns		
Turn-Off Fall Time	t _F	_	4.1	_	ns		
Reverse Recovery Time	T_RR	_	7.3	_	ns		
Reverse Recovery Charge	Q _{RR}		7.9	_	nC	$I_F = 9A$, di/dt = 500A/ μ s	

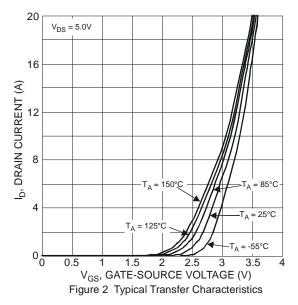
^{5.} Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

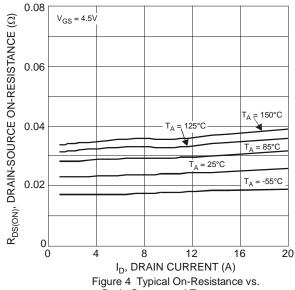
^{7.} I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_{J} = +25$ °C.

^{8.} Short duration pulse test used to minimize self-heating effect.









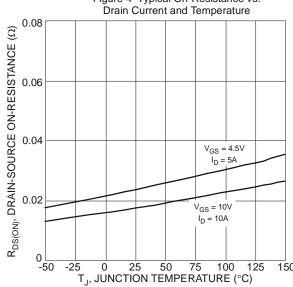
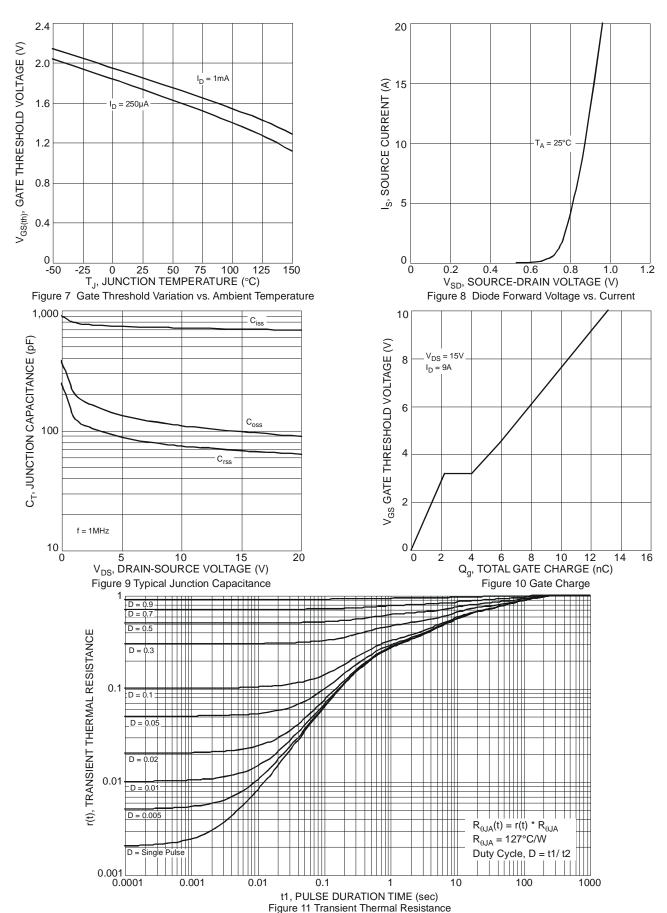


Figure 6 On-Resistance Variation with Temperature



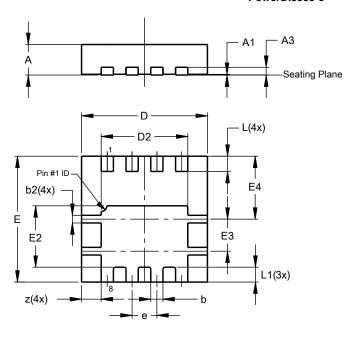




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

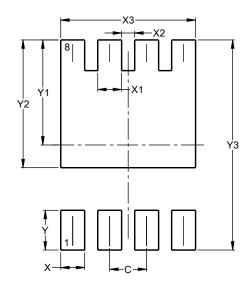


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	_	_	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
E	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е	-	-	0.65		
L	0.35	0.45	0.40		
L1	_	_	0.39		
Z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)		
С	0.650		
X	0.420		
X1	0.420		
X2	0.230		
Х3	2.370		
Υ	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		



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